# NPN - MPS650, MPS651; PNP - MPS750, MPS751

MPS651 and MPS751 are Preferred Devices

# **Amplifier Transistors**

### Features

• Pb–Free Packages are Available\*

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector – Emitter Voltage MPS650; MPS750 MPS651; MPS751	V <sub>CE</sub>	40 60	Vdc
Collector – Base Voltage MPS650; MPS750 MPS651; MPS751	V <sub>CB</sub>	60 80	Vdc
Emitter-Base Voltage	V <sub>EB</sub>	5.0	Vdc
Collector Current – Continuous	Ι <sub>C</sub>	2.0	Adc
Total Power Dissipation @ $T_A = 25^{\circ}C$ Derate above 25°C	PD	625 5.0	mW mW/°C
Total Power Dissipation @ $T_C = 25^{\circ}C$ Derate above 25°C	P <sub>D</sub>	1.5 12	W mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

### THERMAL CHARACTERISTICS

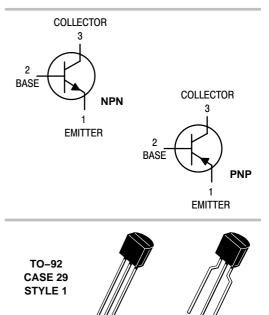
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	V <sub>CE</sub>	200	°C/W
Thermal Resistance, Junction-to-Case	V <sub>CB</sub>	83.3	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



## **ON Semiconductor®**

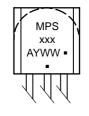
http://onsemi.com



STRAIGHT LEAD BULK PACK



### MARKING DIAGRAM



xxx = 650, 750, 651, or 751 A = Assembly Location Y = Year WW = Work Week

= Pb–Free Package

(Note: Microdot may be in either location)

### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

Preferred devices are recommended choices for future use

and best overall value.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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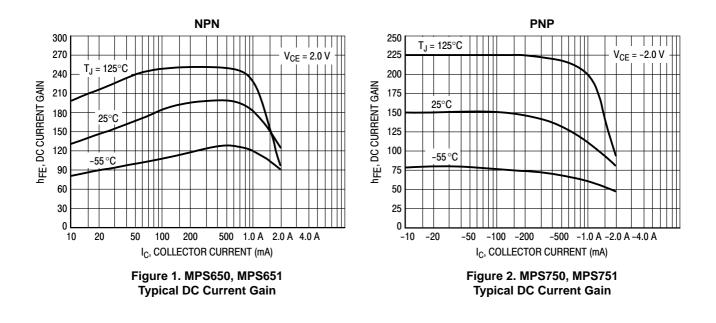
## NPN - MPS650, MPS651; PNP - MPS750, MPS751

### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

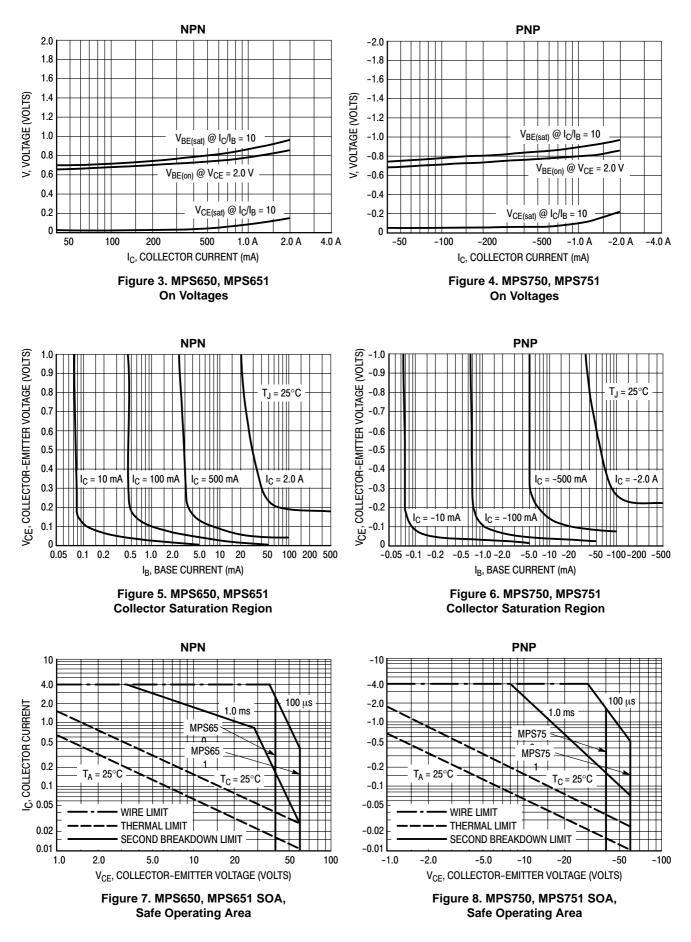
Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS			•		•
Collector – Emitter Breakdown Voltage (Note 1) ( $I_C = 10$ mAdc, $I_B = 0$ )	MPS650, MPS750 MPS651, MPS751	V <sub>(BR)CEO</sub>	40 60		Vdc
Collector – Base Breakdown Voltage ( $I_C = 100 \ \mu Adc, I_E = 0$ )	MPS650, MPS750 MPS651, MPS751	V <sub>(BR)CBO</sub>	60 80		Vdc
Emitter – Base Breakdown Voltage ( $I_C = 0, I_E = 10 \ \mu Adc$ )		V <sub>(BR)EBO</sub>	5.0	-	Vdc
Collector Cutoff Current $(V_{CB} = 60 \text{ Vdc}, I_E = 0)$ $(V_{CB} = 80 \text{ Vdc}, I_E = 0)$	MPS650, MPS750 MPS651, MPS751	I <sub>CBO</sub>		0.1 0.1	μAdc
Emitter Cutoff Current ( $V_{EB} = 4.0 \text{ V}, I_C = 0$ )		I <sub>EBO</sub>	-	0.1	μAdc
ON CHARACTERISTICS (Note 1)	·		•		
$ \begin{array}{l} \text{DC Current Gain} \\ (I_C = 50 \text{ mA}, \text{ V}_{CE} = 2.0 \text{ V}) \\ (I_C = 500 \text{ mA}, \text{ V}_{CE} = 2.0 \text{ V}) \\ (I_C = 1.0 \text{ A}, \text{ V}_{CE} = 2.0 \text{ V}) \\ (I_C = 2.0 \text{ A}, \text{ V}_{CE} = 2.0 \text{ V}) \end{array} $		h <sub>FE</sub>	75 75 75 40	- - - -	_
Collector – Emitter Saturation Voltage ( $I_C = 2.0 \text{ A}, I_B = 200 \text{ mA}$ ) ( $I_C = 1.0 \text{ A}, I_B = 100 \text{ mA}$ )		V <sub>CE(sat)</sub>		0.5 0.3	Vdc
Base–Emitter On Voltage ( $I_C = 1.0 \text{ A}, V_{CE} = 2.0 \text{ V}$ )		$V_{\text{BE(on)}}$	-	1.0	Vdc
Base – Emitter Saturation Voltage ( $I_C = 1.0 \text{ A}, I_B = 100 \text{ mA}$ )		V <sub>BE(sat)</sub>	-	1.2	Vdc
SMALL-SIGNAL CHARACTERISTICS			•	•	•
Current-Gain – Bandwidth Product (Note 2) (I <sub>C</sub> = 50 mAdc, V <sub>CE</sub> = 5.0 Vdc, f = 100 MHz)		f <sub>T</sub>	75	-	MHz

1. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle = 2.0%.

2.  $f_T$  is defined as the frequency at which  $|h_{fe}|$  extrapolates to unity.



### NPN – MPS650, MPS651; PNP – MPS750, MPS751



### NPN – MPS650, MPS651; PNP – MPS750, MPS751

### **ORDERING INFORMATION**

MPS650			
	TO-92	5000 Units / Bulk	
MPS650G	TO-92 (Pb-Free)	5000 Units / Bulk	
MPS650RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel	
MPS650ZL1G	TO-92 (Pb-Free)	2000 / Tape & Ammunition	
MPS651	TO-92	5000 Units / Bulk	
MPS651G	TO–92 (Pb–Free)	5000 Units / Bulk	
MPS651RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel	
MPS651RLRM	TO-92	2000 / Tape & Ammunition	
MPS651RLRMG	TO–92 (Pb–Free)	2000 / Tape & Ammunition	
MPS750G	TO-92 (Pb-Free)	5000 Units / Bulk	
MPS750RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel	
MPS750RLRP	TO-92	2000 / Tape & Ammunition	
MPS750RLRPG	TO-92 (Pb-Free)	2000 / Tape & Ammunition	
MPS751	TO-92	5000 Units / Bulk	
MPS751G	TO-92 (Pb-Free)	5000 Units / Bulk	
MPS751RLRA	TO-92	2000 / Tape & Reel	
MPS751RLRAG	TO–92 (Pb–Free)	2000 / Tape & Reel	
MPS751RLRP	TO-92	2000 / Tape & Ammunition	
MPS751RLRPG	TO-92 (Pb-Free)	2000 / Tape & Ammunition	
MPS751ZL1G	TO-92 (Pb-Free)	2000 / Tape & Ammunition	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AM** NOTES: В STRAIGHT LEAD 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH. BULK PACK 2 CONTOUR OF PACKAGE BEYOND DIMENSION R 3. R IS UNCONTROLLED LEAD DIMENSION IS UNCONTROLLED IN P AND 4. Р BEYOND DIMENSION K MINIMUM L INCHES MILLIMETERS SEATING ĸ DIM MIN MAX MIN MAX A 0.175 0.205 B 0.170 0.210 4 45 5.20 4.32 5.33 С 0.125 0.165 4.19 3.18 **D** 0.016 0.021 0.407 0.533 D G 0.045 0.055 1.15 1.39 H 0.095 2.66 0.105 2.42 G 0.015 0.020 0.39 0.50 J K 0.500 12 70 L 0.250 6.35 -C N 0.080 0.105 2.04 2.66 Ρ 0.100 2.54 SECTION X-X R 0.115 V 0.135 2.93 N 3.43 NOTES: BENT LEAD B 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. R TAPE & REEL CONTROLLING DIMENSION: MILLIMETERS. CONTOUR OF PACKAGE BEYOND AMMO PACK 3. DIMENSION R IS UNCONTROLLED 4 LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM. Ρ Т SEATING MILLIMETERS κ PLANE DIM MIN MAX Δ 4 45 5.20 в 4.32 5.33 С 4.19 3.18 D 0.40 0.54 D G 2.40 2.80 G 0.39 J 0.50 12.70 Κ J 2.04 2.66 Ν Ρ 1.50 4.00 -C R 2.93 SECTION X-X ٧ 3.43 STYLE 1: PIN 1 FMITTER BASE 2. COLLECTOR 3.

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